ATTORNEY DOCKET NO. \_\_\_100203431-1\_\_

Port Collins, Colorado 80527-2400

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Bash et al.

**Confirmation No.:** 

Application No.: 10/664,256

Examiner:

Filing Date:

Sept. 17, 2003

**Group Art Unit:** 

Title:

Dynamic Fluid Sprayjet Delivery System

Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

## INFORMATION DISCLOSURE STATEMENT

Sir:

This Information Disclosure Statement is submitted:

(x) under 37 CFR 1.97(b), or

(Within three months of filing national application; or date of entry of national application; or before mailing date of first office action on the merits; whichever occurs last)
( ) under 37 CFR 1.97 (c) together with either a:
( ) Statement under 37 CFR 1.97(e), or
( ) a \$180.00 fee under 37 CFR 1.17(p), or
( After the CFR 1.97 (b) time period, but before final action or notice of allowance, whichever occurs first)

( ) under 37 CFR 1.97 (d) together with a:

( ) Statement under 37 CFR 1.97(e)(1) or (2), and

( ) a \$180.00 fee set forth in 37 CFR 1.17(p). (Filed after final action, a notice of allowance, on or before payment of the issue fee)

Please charge to Deposit Account **08-2025** the sum of \$0.00 . At any time during the pendency of this application, please charge any fees required or credit any overpayment to Deposit Account **08-2025** pursuant to 37 CFR 1.25.

(X) Applicant(s) submit herewith Form PTO 1449 - Information Disclosure Statement together with any required copies of patents, publications or other information of which applicant(s) are aware, which applicant(s) believe(s) may be material to the examination of this application and for which there may be a duty to disclose in accordance with 37 CFR 1.56.

( ) A concise explanation of the relevance of foreign language patents, foreign language publications and other foreign language information listed on PTO Form 1449, as presently understood by the individuals(s) designated in 37 CFR 1.56 (c) most knowledgeable about the content is given on the attached sheet, or where a foreign language patent is cited in a search report or other action by a foreign patent office in a counterpart foreign application, an English language version of the search report or action which indicates the degree of relevance found by the foreign office is listed on form PTO 1449 and is enclosed herewith.

It is requested that the information disclosed herein be made of record in this application.

(X) I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450. Date of Deposit: October 9, 2003

( ) I hereby certify that this paper is being transmitted to the Patent and Trademark Office facsimile number on

Number of pages:

Typed Name: John Griecoi

Signature: (1)

Respectfully submitted,

Bash et al.

Jøhn Griecci

Attorney/Agent for Applicant(s)

Reg. No. 39,694

Date: Oct. 9, 2003

Telephone No.: (310) 376-6527

Rev 10/03 (IDSCERT)

Confirmation No. oplication No. 10/664,256 BASH et al. Applicant Filed September 17, 2003 Art Unit Examiner Docket No. 100203431-1 22879 10 Customer No. October 9, 2003 Date: Honorable Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 15 DISCLOSURE OF PENDING APPLICATIONS Dear Sir: 20 With respect to the above-identified application, Applicants respectfully note that the following patent applications include claims directed to related technologies: U.S. Patent Application, Serial No. 09/945,044, filed August 31, 2001; U.S. Patent Application, Serial No. 10/023,227, filed December 14, 2001; and 25 U.S. Patent Application, Serial No. 10/384,456, filed March 7, 2003. The filing of this disclosure should not be construed to be either a suggestion or an

The filing of this disclosure should not be construed to be either a suggestion or an admission that the cited applications are, or are considered to be, material to patentability under 37 C.F.R. § 1.56(b).

Respectfully submitted,

Bash et al.

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By:

John A. Griecci

Registration No. 39,694

For: The Law Office of John A. Griecci

703 Pier Avenue, Suite B #657 Hermosa Beach, CA 90254 (310) 376-6527

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**FORM PTO-1449** 

LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT

(Use several sheets if necessary)

ATTY. DOCKET NO. 100203431-1

SERIAL NO. 10/664,256

BASH et al.

FILING DATE
September 17, 2003

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